

PATENT

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Present Application:

Applicants : Vishnu K. Agarwal and
Scott G. Meikle

Attorney Docket No. : 500453.04

Filed : Concurrently herewith

Title : POLISHING PADS AND PLANARIZING MACHINES FOR MECHANICAL
OR CHEMICAL-MECHANICAL PLANARIZATION OF
MICROELECTRONIC-DEVICE SUBSTRATE ASSEMBLIES, AND
METHODS FOR MAKING AND USING SUCH PADS AND MACHINES

Prior Application:

Examiner : William P. Fletcher III

Art Unit : 1762

Serial No. : 09/621,021

PRELIMINARY AMENDMENT

Box Patent Application
Commissioner of Patents
Washington, D.C. 20231

Sir:

Please amend the above-identified application as follows:

In the Specification:

Amend the specification by inserting a new section before the "Technical Field"

as follows:

~~-- CROSS-REFERENCE TO RELATED APPLICATIONS~~

*A
SJP*
This application is a continuation of pending United States Patent Application
No. 09/621,021, filed July 21, 2000, which is a divisional of United States Patent Application
No. 09/201,576, filed November 30, 1998. --

In the Claims:

✓
Please cancel claims 1-54, 58, 60-64, 65-68, 71, and 73-79.

Respectfully submitted,

DORSEY & WHITNEY LLP

Steven Arterberry

Steven H. Arterberry
Registration No. 46,314

SHA:tdg

1420 Fifth Avenue, Suite 3400
Seattle, WA 98101-4010
(206) 903-8800 (telephone)
(206) 903-8820 (fax)

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